# 2SC5931

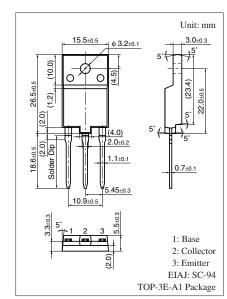
## Silicon NPN triple diffusion mesa type

Horizontal deflection output for TV, CRT monitor

### Features

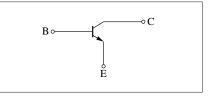
- High breakdown voltage:  $V_{CBO} \ge 1700 \text{ V}$
- High speed switching:  $t_f < 200$  ns
- Wide safe operation area

#### Absolute Maximum Ratings $T_C = 25^{\circ}C$ Parameter Symbol Rating Unit Collector-base voltage (Emitter open) V<sub>CBO</sub> 1700 V Collector-emitter voltage (E-B short) VCES 1700 V V Collector-emitter voltage (Base open) V<sub>CEO</sub> 600 Emitter-base voltage (Collector open) 7 V $V_{EBO}$ Base current $I_{\rm B}$ 7.5 Α Collector current $I_C$ 15 А Peak collector current \* 25 I<sub>CP</sub> А Collector power dissipation 60 W $P_C$ $T_a = 25^{\circ}C$ 3 °C Junction temperature Ti 150 $T_{stg}$ °C Storage temperature -55 to +150



### Marking Symbol: C5931

### Internal Connection



Note) \*: Non-repetitive peak collector current

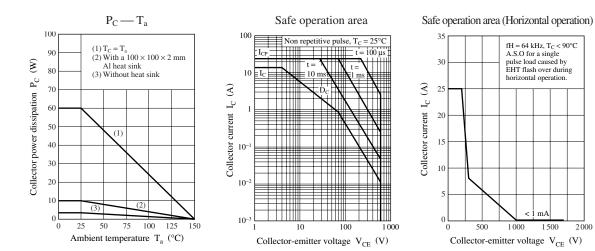
Electrical Characteristics T

Devenenter	Currente e l	Conditions	Min	Tran	Max	Linit
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 1000 \text{ V}, I_E = 0$			50	μΑ
		$V_{CB} = 1700 \text{ V}, I_E = 0$			1	mA
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = 7 V, I_C = 0$			50	μΑ
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 5 \text{ V}, I_C = 7.5 \text{ A}$	5		10	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 7.5 \text{ A}, I_B = 1.88 \text{ A}$			3	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{C} = 7.5 \text{ A}, I_{B} = 1.88 \text{ A}$			1.5	V
Transition frequency	f <sub>T</sub>	$V_{CE} = 10 \text{ V}, I_C = 0.1 \text{ A}, f = 0.5 \text{ MHz}$		3		MHz
Storage time	t <sub>stg</sub>	$I_C = 7.5 \text{ A}$ , Resistance loaded			2.7	μs
Fall time	t <sub>f</sub>	$I_{B1} = 1.88 \text{ A}, I_{B2} = -3.75 \text{ A}$			0.2	μs

2500 1 200

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

## **Panasonic**



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